

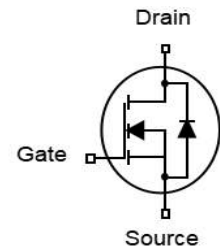
Features

- N-Channel
- Low $R_{DS(on)}$ & FOM
- Low C_{rss}
- 100% Avalanche Tested
- Improved dv/dt Capability
- 100% EAS Tested

V_{DS}	30	V
$R_{DS(on),TYP}@ V_{GS}=10V$	1.5	$m\Omega$
$R_{DS(on),TYP}@ V_{GS}=4.5V$	2.3	$m\Omega$
I_D	140	A

DFN5x6


Part ID	Package Type	Marking	Packing
ZT016N03G	DFN5x6	ZT016N03G	5000pcs/Reel



Absolute Maximum Ratings $T_A=25^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit	
Common Ratings ($T_C=25^\circ\text{C}$ Unless Otherwise Noted)				
V_{GS}	Gate-Source Voltage	± 20	V	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	30	V	
T_J	Maximum Junction Temperature	150	$^\circ\text{C}$	
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$	
I_{DM}	Drain Current-Continuous@ Current-Pulsed (Note 3)	$T_C=25^\circ\text{C}$ 520	A	
Mounted on Large Heat Sink				
I_D	Drain Current-Continuous (Note 2)	$T_C=25^\circ\text{C}$	140	A
		$T_C=100^\circ\text{C}$	87	A
P_D	Maximum Power Dissipation	55	W	
$R_{\theta JC}$	Thermal Resistance-Junction to Case	2.3	$^\circ\text{C/W}$	
Drain-Source Avalanche Ratings				
EAS	Avalanche Energy, Single Pulsed (Note 1)	480	mJ	

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J=25°C (unless otherwise stated)						
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	30	--	--	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V	--	--	1	μA
IGSS	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	1.6	2.2	V
RDS(on)	Drain-Source On-State Resistance	V _{GS} =10V, I _D =20A	--	1.5	1.95	mΩ
RDS(on)	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =10A	--	2.3	3.2	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated) (Note 5)						
Ciss	Input Capacitance	V _{DS} =25V, V _{GS} =0V, f=1MHz	--	5680	--	pF
Coss	Output Capacitance		--	520	--	pF
Crss	Reverse Transfer Capacitance		--	496	--	pF
Qg	Total Gate Charge	V _{DS} =15V, I _D =40A, V _{GS} =10V	--	109	--	nC
Qgs	Gate-Source Charge		--	20	--	nC
Qgd	Gate-Drain Charge		--	24	--	nC
Switching Characteristics (Note 5)						
Td(on)	Turn-on Delay Time	V _{DS} =15V, I _D =30A, R _G =3.3Ω, V _{GS} =10V	--	11	--	ns
Tr	Turn-on Rise Time		--	10	--	ns
Td(off)	Turn-Off Delay Time		--	75	--	ns
Tf	Turn-Off Fall Time		--	27	--	ns
Source- Drain Diode Characteristics @ T_J = 25°C (unless otherwise stated)						
IS	Diode Forward Current (Note 3)		--	--	140	A
VSD	Forward on voltage (Note 6)	I _S =20A, V _{GS} =0V	--	--	1.2	V
Trr	Reverse Recovery Time (Note 4)	T _J =25°C, I _F =30A di/dt=100A/μs	--	--	22	ns
Qrr	Reverse Recovery Charge		--	--	13	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. EAS condition: T_J =25°C, V_{DD} =20V, V_G =10V, R_G =25Ω, L=0.5mH,
3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

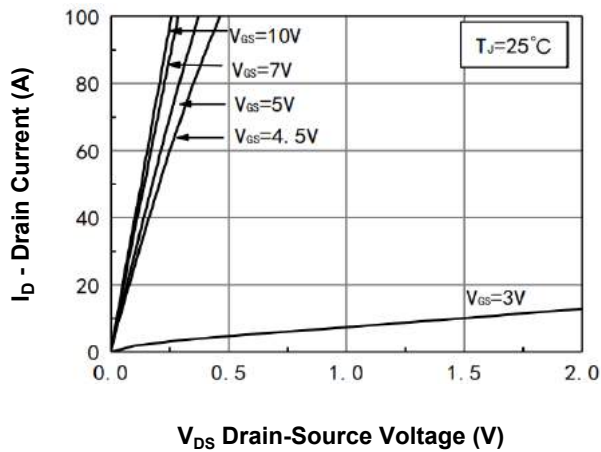


Figure 1. On-Region Characteristics

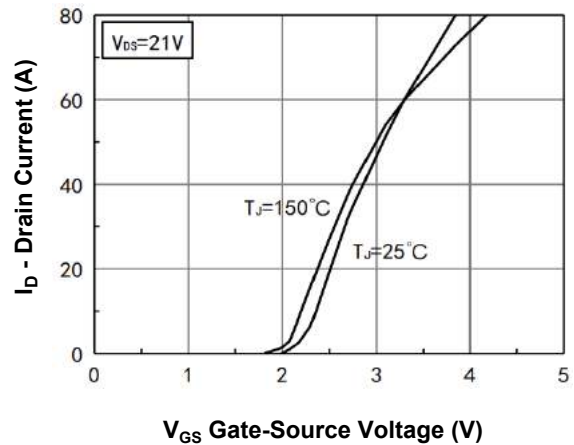


Figure 4. Transfer Characteristics

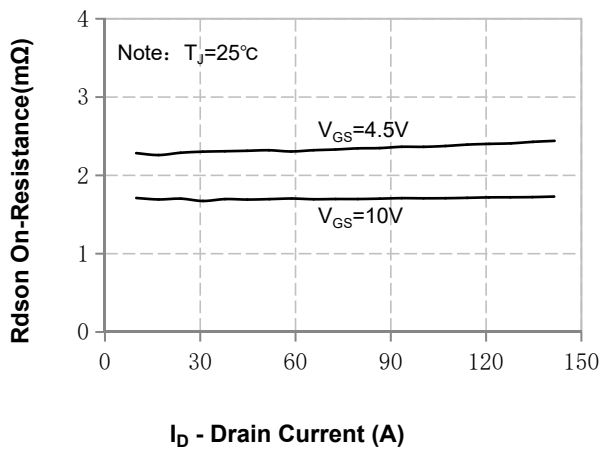


Figure 2. On-Resistance Variation vs Drain Current and Gate Voltage

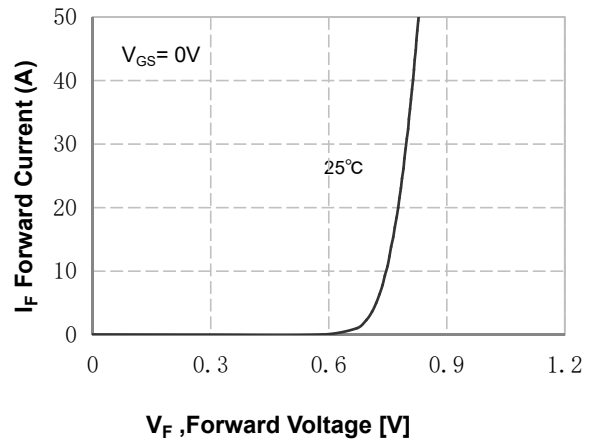


Figure 5. Body Diode Forward Voltage Variation vs Source Current

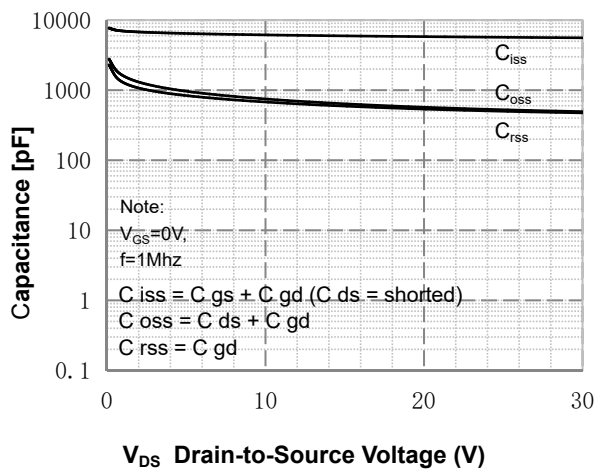


Figure 3. Capacitance Characteristics

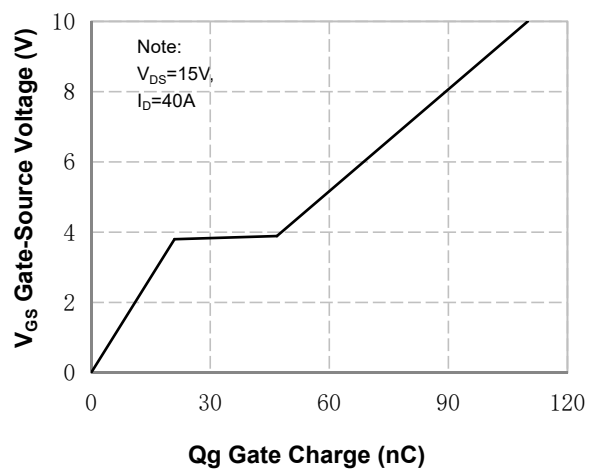


Figure 6. Gate Charge Characteristics

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

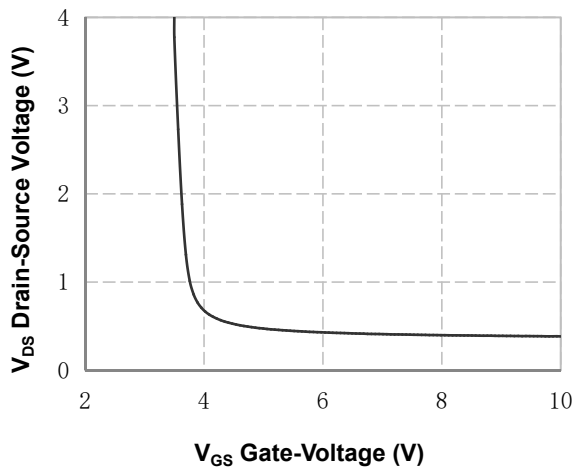


Figure 7. Vds Drain-Source Voltage vs Gate Voltage

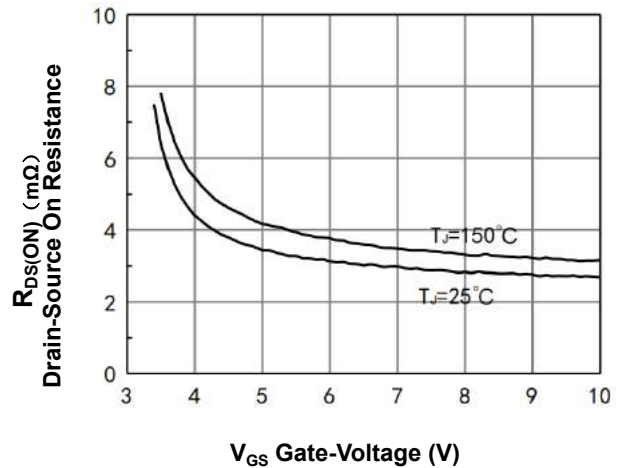


Figure 9. On-Resistance vs Gate Voltage

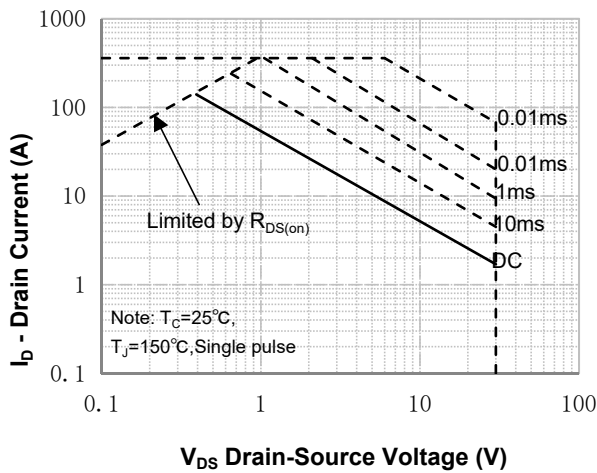


Figure 8. Maximum Safe Operating Area

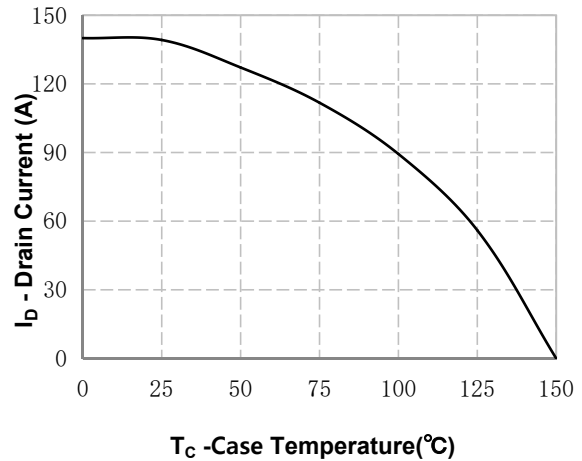


Figure 10. Maximum Continuous Drain Current vs Case Temperature

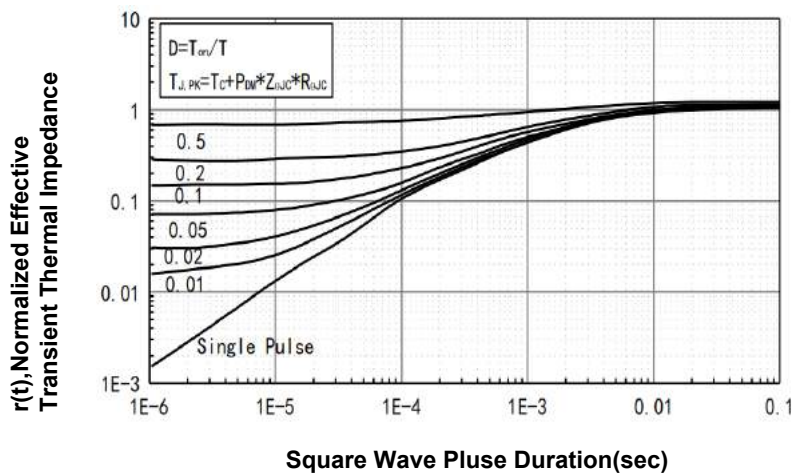


Figure 11. Transient Thermal Response Curve

Figure A: Gate Charge Test Circuit and Waveform

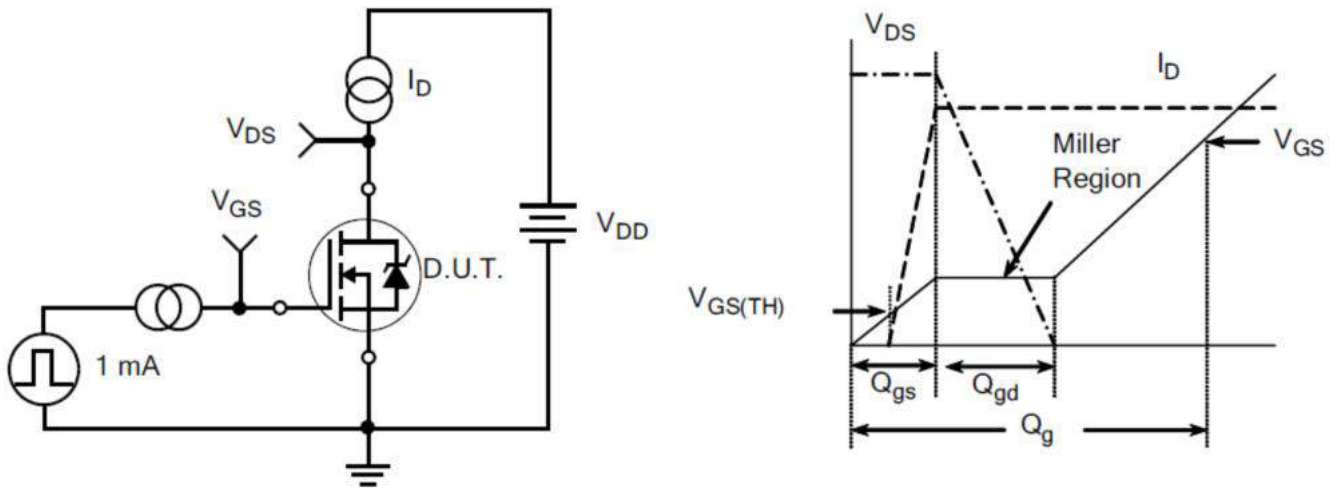


Figure B: Resistive Switching Test Circuit and Waveform

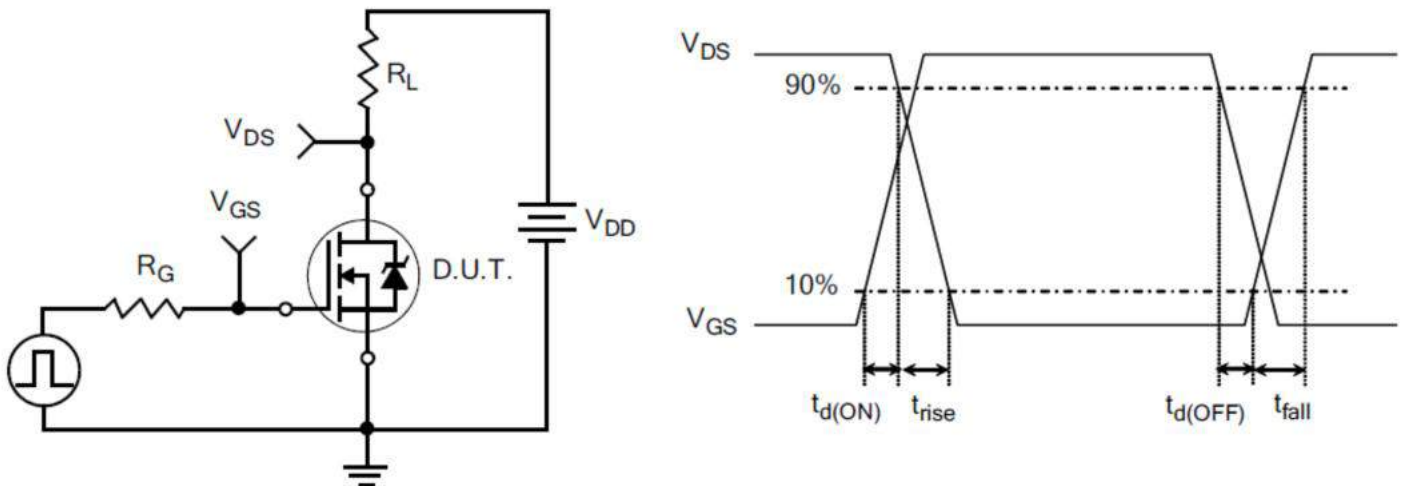
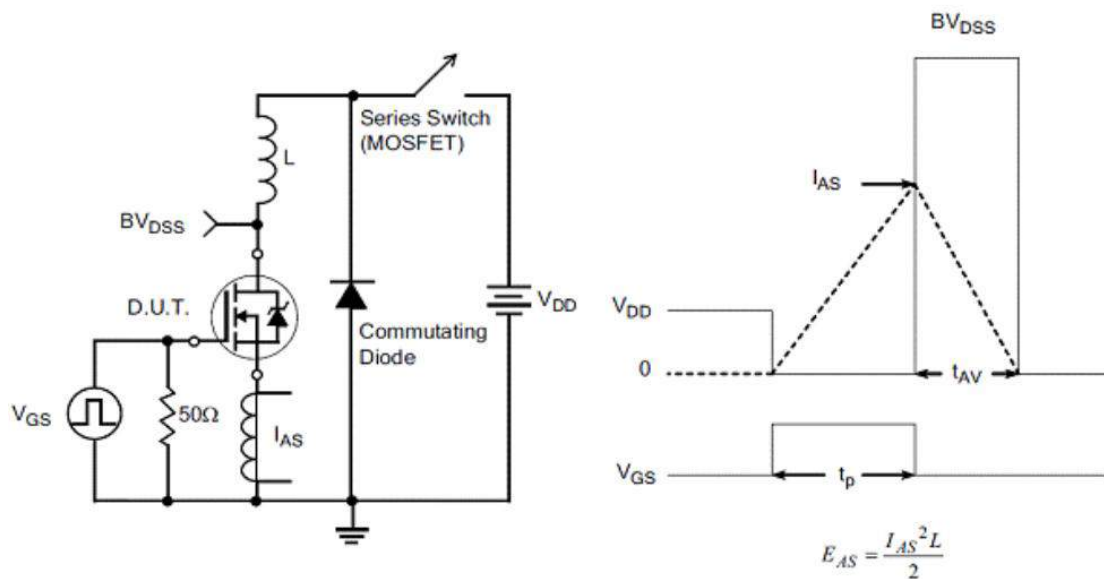
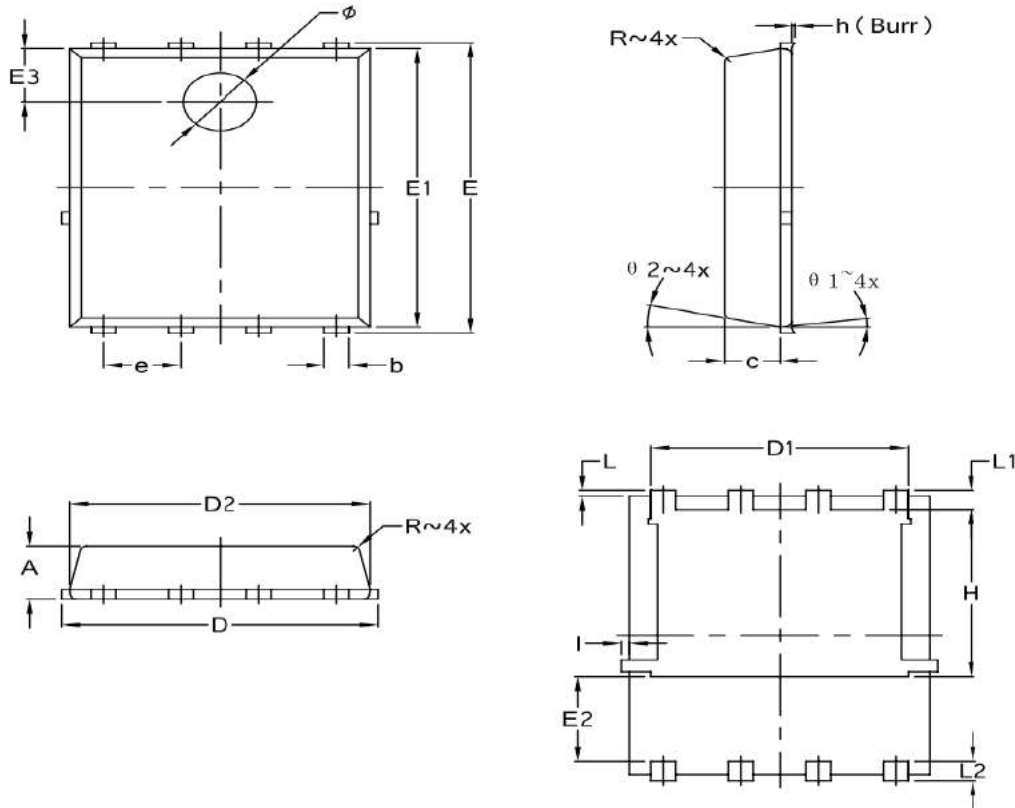


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



DFN5x6-8L Package Information



SYMBOL	COMMON			
	MM		INCH	
	MIN.	MAX.	MIN.	MAX.
A	1.03	1.17	0.0406	0.0461
b	0.35	0.46	0.0138	0.0181
c	0.84	0.95	0.0331	0.0374
D	4.83	5.37	0.1902	0.2114
D1	4.14	4.28	0.1630	0.1685
D2	4.83	4.97	0.1902	0.1957
E	6.03	6.13	0.2374	0.2413
E1	5.68	5.82	0.2236	0.2291
E2	1.65	—	0.0650	—
E3	1.03	1.17	0.0406	0.0461
e	1.27 BSC		0.0500 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.40	0.48	0.0157	0.0189
L2	0.40	0.48	0.0157	0.0189
H	3.315	3.475	0.1305	0.1368
I	—	0.16	—	0.0063
ϕ	1.13	1.27	0.0445	0.0500
R	0.10		0.0039	
$\theta 1$	7° REF		7° REF	
$\theta 2$	12° REF		12° REF	
h	0.08 MAX		0.0031	

Customer Service

Sales and Service:

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